

MOS FIELD EFFECT TRANSISTOR

2SK3434

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK3434 is N-channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

- Super low on-state resistance
- $R_{DS(on)1} = 20 \text{ m}\Omega \text{ MAX.} (V_{GS} = 10 \text{ V}, \text{ ID} = 24 \text{ A})$
- $R_{DS(on)2} = 31 \text{ m}\Omega \text{ MAX.} (V_{GS} = 4.0 \text{ V}, \text{ ID} = 24 \text{ A})$
- Low Ciss: $C_{iss} = 2100 \text{ pF TYP}$.
- Built-in gate protection diode

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage	Vdss	60	V
Gate to Source Voltage	Vgss	±20	V
Drain Current (DC)	D(DC)	±48	А
Drain Current (pulse) Note1	D(pulse)	±120	А
Total Power Dissipation (Tc = 25° C)	Ρτ	56	W
Total Power Dissipation ($T_A = 25^{\circ}C$)	Ρτ	1.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note2	las	28	А
Single Avalanche Energy ^{Note2}	Eas	78	mJ

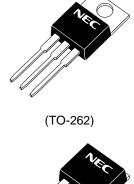
Notes 1. PW \leq 10 μ s, Duty cycle \leq 1%

2. Starting T_{ch} = 25°C, R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3434	TO-220AB
2SK3434-S	TO-262
2SK3434-ZJ	TO-263
2SK3434-Z	TO-220SMD ^{Note}

Note TO-220SMD package is produced only in Japan.



(TO-220AB)



(TO-263, TO-220SMD)



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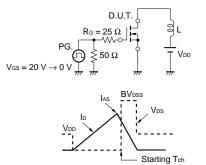
Document No. Date Published Printed in Japan

ELECTRICAL CHARACTERISTICS (TA = 25 °C)

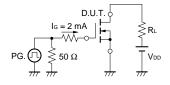
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Drain Current	loss	$V_{DS} = 60 V, V_{GS} = 0 V$			10	μA
Gate Cut-off Voltage	VGS(off)	Vds = 10 V, Id = 1 mA	1.5	2.0	2.5	V
Forward Transfer Admittance	y fs	Vds = 10 V, Id = 24 A	13	27		S
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, Id = 24 A		16	20	mΩ
	RDS(on)2	$V_{GS} = 4.0 V, I_{D} = 24 A$		22	31	mΩ
Input Capacitance	Ciss	VDS = 10 V		2100		pF
Output Capacitance	Coss	V _{GS} = 0 V		340		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		170		pF
Turn-on Delay Time	td(on)	Vdd = 30 V, Id = 24 A		40		ns
Rise Time	tr	VGS(on) = 10 V		400		ns
Turn-off Delay Time	td(off)	R _G = 10 Ω		120		ns
Fall Time	tr			160		ns
Total Gate Charge	QG	Vdd = 48 V		40		nC
Gate to Source Charge	QGS	Vgs = 10 V		7		nC
Gate to Drain Charge	Qgd	ID = 48 A		11		nC
Body Diode Forward Voltage	VF(S-D)	IF = 48 A, VGs = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 48 A, VGs = 0 V		43		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/µs		61		nC

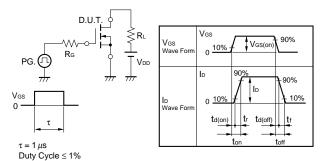
TEST CIRCUIT 2 SWITCHING TIME

TEST CIRCUIT 1 AVALANCHE CAPABILITY



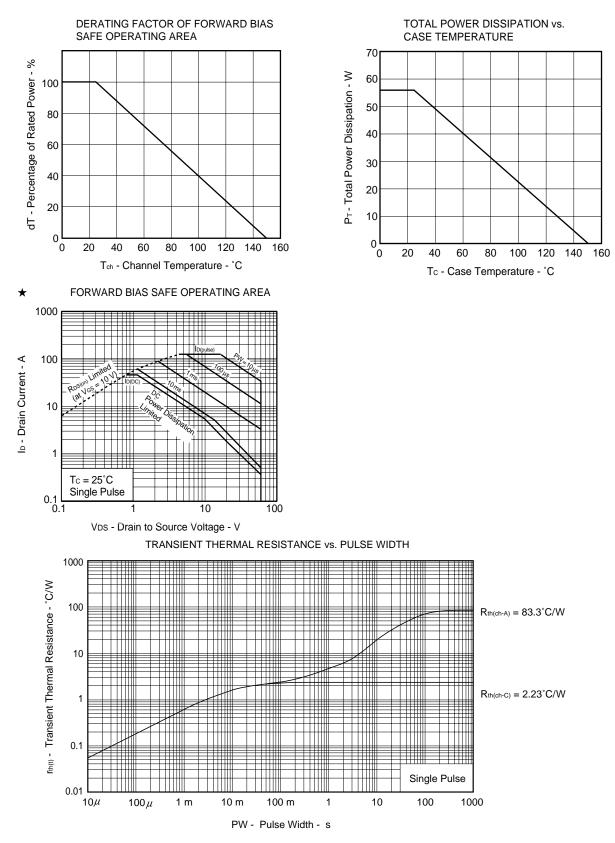
TEST CIRCUIT 3 GATE CHARGE



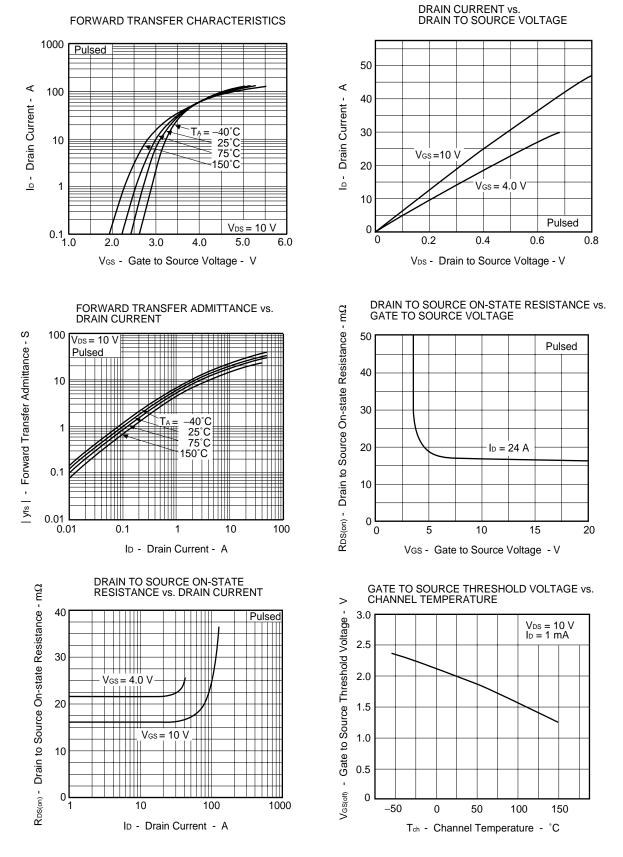


Data Sheet D14603EJ2V0DS

TYPICAL CHARACTERISTICS (TA = 25°C)

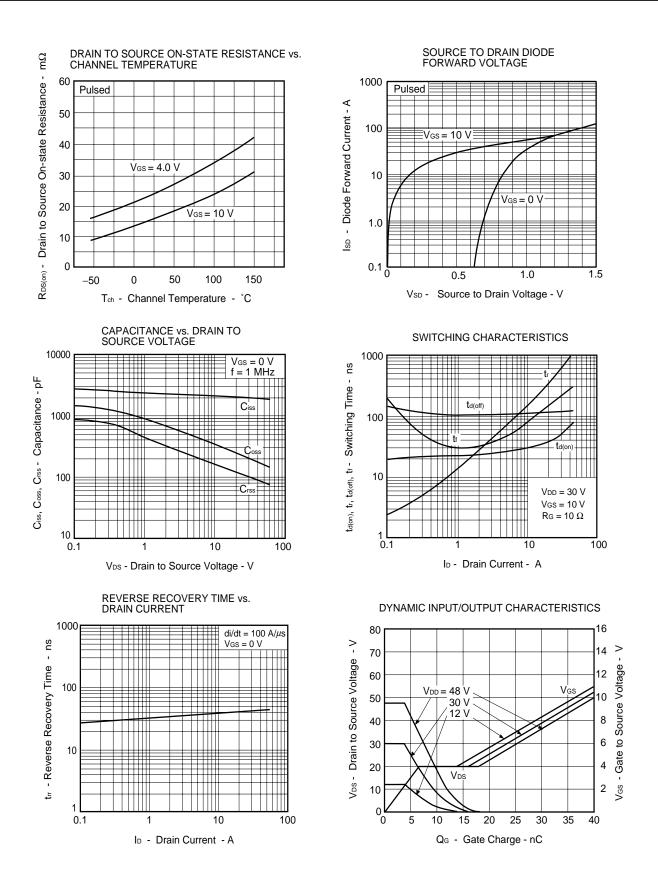


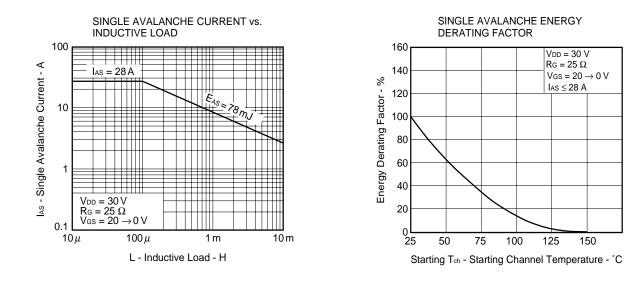
Data Sheet D14603EJ2V0DS



Data Sheet D14603EJ2V0DS

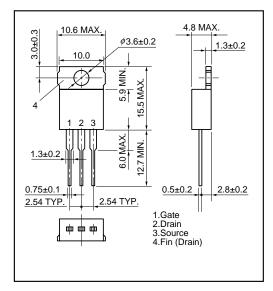
NEC



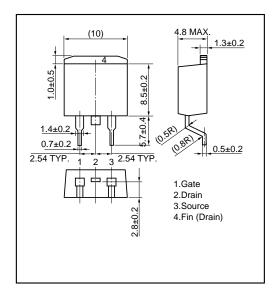


PACKAGE DRAWINGS (Unit: mm)

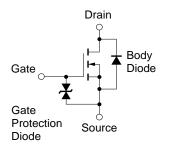
1) TO-220AB(MP-25)



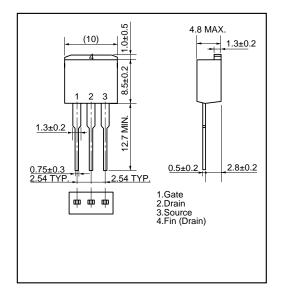
3) TO-263 (MP-25ZJ)



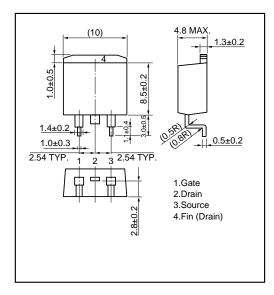
EQUIVALENT CIRCUIT



2) TO-262(MP-25 Fin Cut)



4) TO-220SMD(MP-25Z)^{Note}



Note This package is produced only in Japan.

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

Data Sheet D14603EJ2V0DS

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